

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE60H10K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. This device is suitable for use in PWM, load switching and general purpose applications.

General Features

• $V_{DS} = 60V, I_D = 100A$ $R_{DS(ON)} < 5.5 \text{ m}\Omega @ V_{GS} = 10V$ (Typ:4.8m Ω)

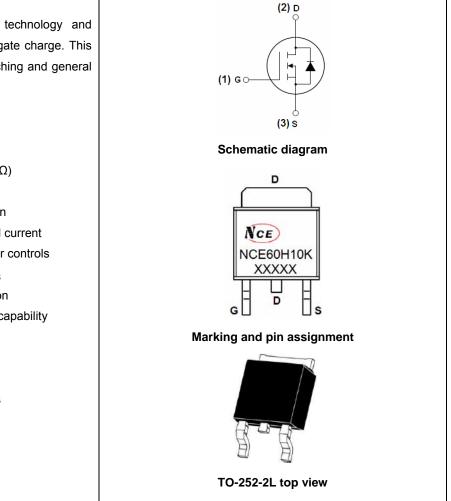
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Special designed for convertors and power controls
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard switched and High frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



Package Marking and Ordering Information

Γ	Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
	NCE60H10K	NCE60H10K	TO-252-2L	-	-	-

Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	60	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	Ι _D	100	А
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	70	А
Pulsed Drain Current	I _{DM}	320	А
Maximum Power Dissipation	PD	170	W
Derating factor		1.13	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	812	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	°C



Thermal Characteristic

Electrical Characteristics (T_A=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics		•		•		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·	·		•		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	2	2.85	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =20A	-	4.8	5.5	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =20A	-	50	-	S
Dynamic Characteristics (Note4)	·	·		•		
Input Capacitance	C _{lss}		-	4900	-	PF
Output Capacitance	C _{oss}	V _{DS} =25V,V _{GS} =0V,	-	380	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	290	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	17	-	nS
Turn-on Rise Time	tr	VDD=35V,RL=15Ω	-	11	-	nS
Turn-Off Delay Time	t _{d(off)}	RG=2.5Ω,VGS=10V	-	55	-	nS
Turn-Off Fall Time	t _f		-	15	-	nS
Total Gate Charge	Qg	N/ 00)// 000	-	100	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =30V,I _D =20A,	-	21	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	30	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-	-	1.2	V
Diode Forward Current (Note 2)	I _S		-	-	100	Α
Reverse Recovery Time	t _{rr}	Tj=25℃,I _F =100A	-		37	nS
Reverse Recovery Charge	Qrr	di/dt=100A/µs ^(Note3)	-		58	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by		y LS+LD)		

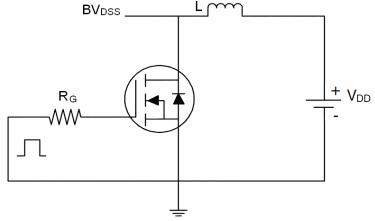
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25 $^{\circ}$ C,V_{DD}=35V,V_G=10V,L=0.5mH,Rg=25 Ω

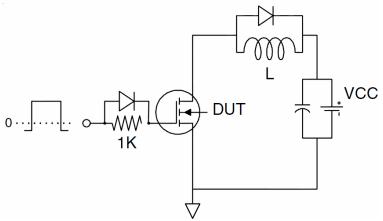


Test Circuit

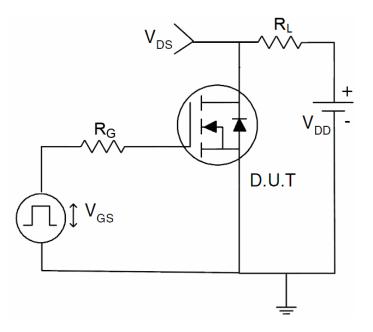
1) E_{AS} Test Circuits



2) Gate Charge Test Circuit

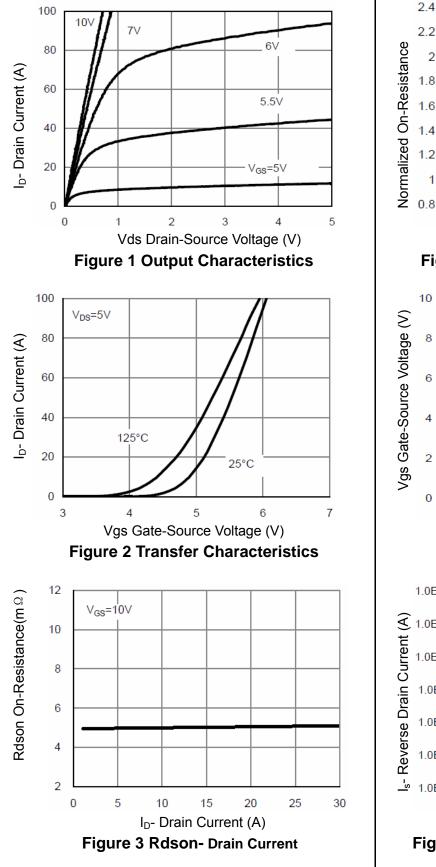


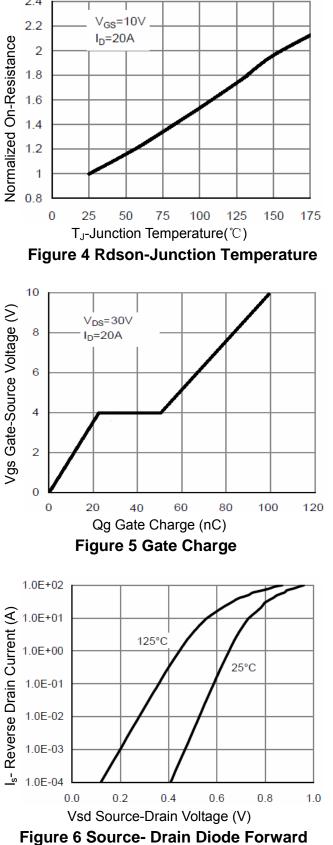
3) Switch Time Test Circuit





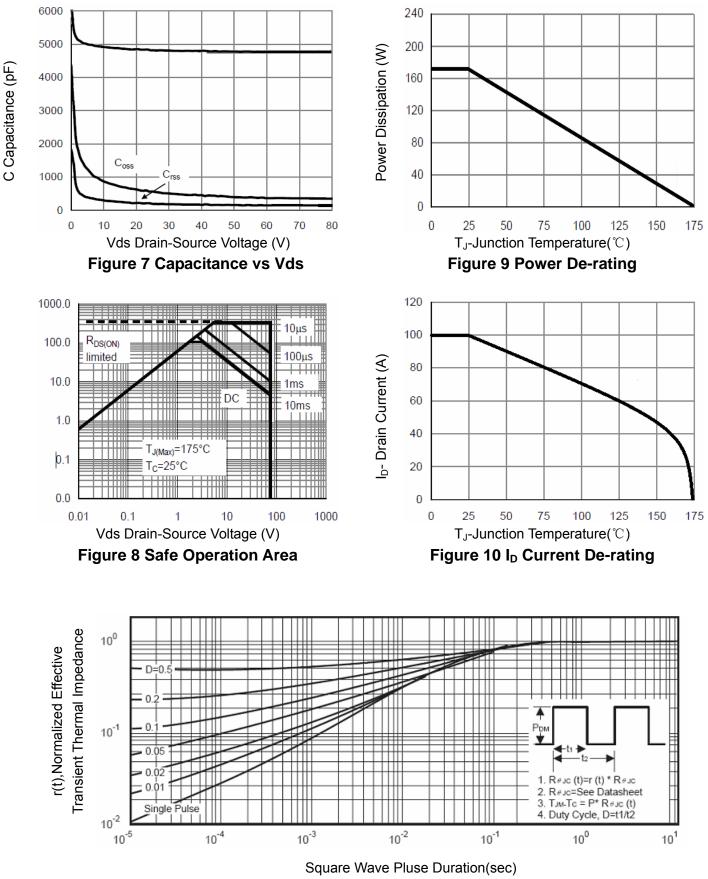
Typical Electrical and Thermal Characteristics (Curves

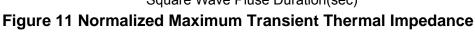






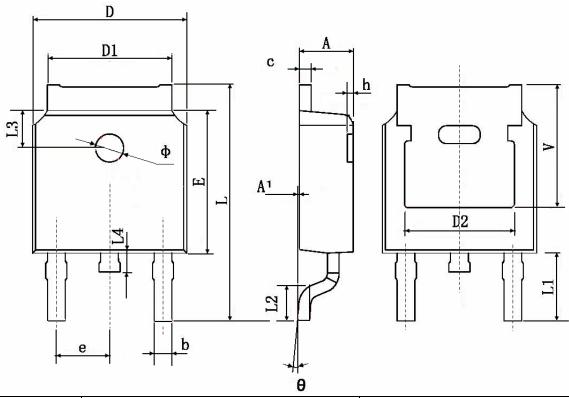
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TO-252 Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches			
Symbol	Min.	Max.	Min.	Max.		
A	2.200	2.400	0.087	0.094		
A1	0.000	0.127	0.000	0.005		
b	0.660	0.860	0.026	0.034		
С	0.460	0.580	0.018	0.023		
D	6.500	6.700	0.256	0.264		
D1	5.100	5.460	0.201	0.215		
D2	0.483	B TYP.	0.190 TYP.			
E	6.000	6.200	0.236	0.244		
e	2.186	2.386	0.086	0.094		
L	9.800	10.400	0.386	0.409		
L1	2.900	2.900 TYP.		0.114 TYP.		
L2	1.400	1.700	0.055	0.067		
L3	1.600	TYP.	0.063 TYP.			
L4	0.600	1.000	0.024	0.039		
Φ	1.100	1.300	0.043	0.051		
θ	0°	8°	0°	8°		
h	0.000	0.300	0.000	0.012		
V	5.350) TYP.	0.211 TYP.			



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